

Through Hole Lamp Product Data Sheet

LTL2V3EQ3J Spec No.: DS20-2013-0087 Effective Date: 05/03/2014 Revision: B



BNS-OD-FC001/A4

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Through Hole Lamp LTL2V3EQ3J

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<u>Rev</u>	Description	<u>By</u>	Date
	Above data for PD and Customer tracki	ng only	
-	NPPR Received and Upload on OPNC	Pitak M.	05/01/2013
В	New Data Sheet format and Change packing	Javy Huang	04/22/2014





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1. Description

Through-hole LEDs are offered in a variety of packages such as 3mm, 4mm, 5mm, rectangular, and cylinder which are suitable for all applications requiring status indication. Several intensity and viewing angle choices are available in each color for design flexibility.

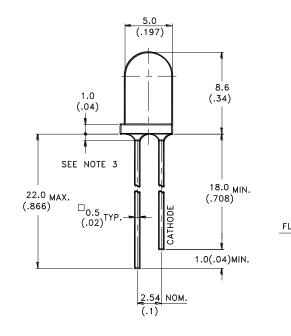
1.1. Features

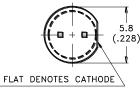
- Low power consumption & High efficiency.
- Lead free & RoHS Compliant.
- Popular T-13/4 diameter.
- Source color is AlInGaP red with white diffused Lens.
- LED Lead frame has cutting.
- Halogen free product (Cl<900ppm, Br<900ppm; Cl+Br<1500ppm)

1.2. Applications

- Computer
- Communication
- Consumer
- Home appliance
- Industrial

2. Outline Dimensions





Notes :

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm (.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.





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3. Absolute Maximum Ratings at TA=25 $^\circ\!\!\mathbb{C}$

Parameter	Maximum Rating	Unit		
Power Dissipation	125	mW		
Peak Forward Current				
(Duty Cycle \leq 1/10, Pulse Width \leq 10ms)	110	mA		
DC Forward Current	50	mA		
Derating Linear From 60° C	0.57	mA/°C		
Operating Temperature Range	-40°C to + 100	-40°C to + 100°C		
Storage Temperature Range	-55°C to + 100	-55°C to + 100°C		
Lead Soldering Temperature				
[2.0mm (.079") From Body]	260°C for 5 Second	260°C for 5 Seconds Max.		

4. Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
	IV	17.6	-	36.5	mW/sr	IF = 20mA
Luminous Intensity						Note 1,3,5
Viewing Angle	201/2		30		deg	Note 2 (Fig.6)
	λP	626	000		nm	Measurement
Peak Emission Wavelength			020			@Peak (Fig.1)
Dominant Wavelength	λd		624		nm	Note 4
Spectral Line Half-Width	Δλ		17		nm	
Forward Voltage	VF		2.1	2.5	V	IF = 20mA
Reverse Current	IR			10	μA	VR = 5V, Note 6

NOTE:

1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 5. Iv guarantee must be included with $\pm 15\%$ testing tolerance.

6. Reverse voltage (VR) condition is applied for IR test only. The device is not designed for reverse operation.

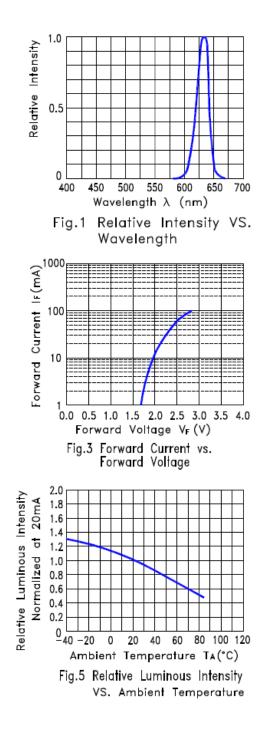


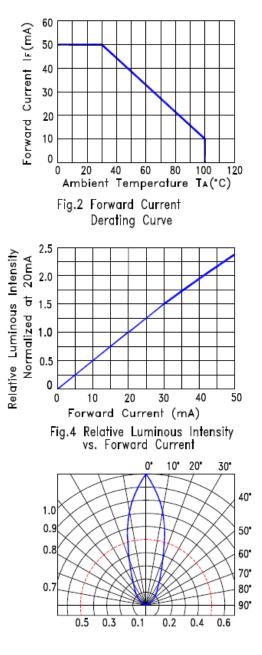


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5. Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)







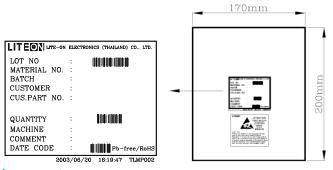
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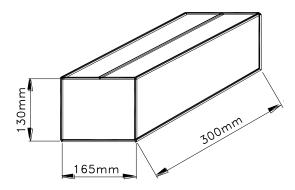
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6. Packing Specification

500, 200 or 100 pcs per packing bag



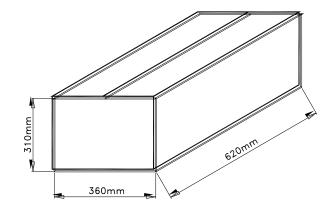
12 packing bags per inner carton Total 6,000 pcs per inner carton



8 Inner cartons per outer carton

Total 48,000 pcs per outer carton

In every shipping lot, only the last pack will be non-full packing





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7. Bin Table Specification

Luminous Intensity Ie, Unit: mW/sr, IF=20mA				
le Bin Code	Min.	Max.		
Р	17.6	21.2		
Q	21.2	25.4		
R	25.4	30.5		
S	30.5	36.5		

Note: Tolerance of each bin limit is ±15%

Forward Voltage Vf, Unit :V (Volts), IF=20mA				
Vf Bin Code	Min.	Max.		
1	1.8	2.0		
2	2.0	2.2		
3	2.2	2.4		
4	2.4	2.5		

Note: Tolerance of each bin limit is ±0.1V





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8. CAUTIONS

8.1. Application

This LED lamp is good for application of indoor and outdoor sign, also ordinary electronic equipment.

8.2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

8.3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

8.4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

8.5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens/Holder to the soldering point. Dipping the lens/Holder into the solder must be avoided. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

	Soldering iron	Wave soldering		
Temperature Soldering time Position	350°C Max. 3 seconds Max. (one time only) No closer than 2mm from the base of the epoxy bulb	Pre-heat Pre-heat time Solder wave Soldering time Dipping Position	100°C Max. 60 seconds Max. 260°C Max. 5 seconds Max. No lower than 2mm from the base of the epoxy bulb	

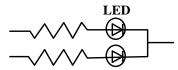
Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

8.6. Drive Method

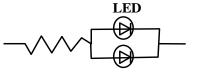
(A) Recommended circuit

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.





Circuit model (B)



(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.



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8.7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Suggested checking list:

Training and Certification

8.7.1.1. Everyone working in a static-safe area is ESD-certified?

8.7.1.2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

8.7.2.1. Static-safe workstation or work-areas have ESD signs?

- 8.7.2.2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 8.7.2.3. All ionizer activated, positioned towards the units?
- 8.7.2.4. Each work surface mats grounding is good?

Personnel Grounding

- 8.7.3.1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 8.7.3.1. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 8.7.3.2. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 8.7.3.3. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 8.7.3.4. All wrist strap or heel strap checkers calibration up to date?
 - Note: *50V for Blue LED.

Device Handling

8.7.4.1. Every ESDS items identified by EIA-471 labels on item or packaging?

- 8.7.4.2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 8.7.4.3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 8.7.4.4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 8.7.5.1. Audit result reported to entity ESD control coordinator?
- 8.7.5.2. Corrective action from previous audits completed?
- 8.7.5.3. Are audit records complete and on file?







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9. Reliability Test

Classification	Test Item	Test Condition	Sample Size	Reference Standard
	Operation Life	Ta = Under Room Temperature IF= Per Data Sheet Maximum Rating Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
Endurance	High Temperature High Humidity storage (THB)	Ta = 60°C RH = 90% Test Time= 240hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
Test	High Temperature Storage	Ta= 105 ± 5°C Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low Temperature Storage	Ta= -55 ± 5°C Test Time= 1000hrs	22 PCS (CL=90%; LTPD=10%)	JEITA ED-4701:200 202 (2001)
	Temperature Cycling	105° C $\sim 25^{\circ}$ C $\sim -55^{\circ}$ C $\sim 25^{\circ}$ C 30mins 5mins 30mins 5mins 10 Cycles	22 PCS (CL=90%; LTPD=10%)	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)
Environmental	Thermal Shock	$105 \pm 5^{\circ}$ C $\sim -55^{\circ}$ C $\pm 5^{\circ}$ C 10 mins 10 mins 10 Cycles	22 PCS (CL=90%; LTPD=10%)	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
Test	Solder Resistance	T.sol = 260 °C Max. Dwell Time= 5secs Max.	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)
	Solderability	T. sol = 230 ± 5°C Dwell Time= 5 ± 1secs	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

10. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

